

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT7145088

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
KEVIN CEURTER	10/03/1994
RUSSELL AOKI	05/06/2018
ANTHONY VALPIANI	05/01/2018
ERIC W. BUDDRIUS	04/11/2018
MUSTAFA HASWAREY	04/10/2018
ROLF LAIDO	04/10/2018
THOMAS BOYD	04/10/2018
BIJOYRAJ SAHU	04/11/2018
SHELBY A. FERGUSON	04/10/2018
RACHEL TAYLOR	04/18/2018
DANIEL NEUMANN	03/10/2018
RECEIVING PARTY DATA	
Name:	INTEL CORPORATION
Street Address:	2200 MISSION COLLEGE BLVD.
City:	SANTA CLARA
State/Country:	CALIFORNIA
Postal Code:	95054
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15942263
CORRESPONDENCE DATA	
Fax Number:	(503)662-7727
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	503-968-8233
Email:	dmontgomery@essentialpatents.com
Correspondent Name:	ESSENTIAL PATENTS GROUP, LLP.
Address Line 1:	5 CENTERPOINTE DRIVE
Address Line 2:	SUITE 400
Address Line 4:	LAKE OSWEGO, OREGON 97035

ATTORNEY DOCKET NUMBER:	01.D143893-US
NAME OF SUBMITTER:	DANA M. MONTGOMERY
SIGNATURE:	/Dana M. Montgomery/
DATE SIGNED:	01/27/2022

Total Attachments: 13

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ASSIGNMENT

In consideration of good and valuable consideration, the receipt of which is hereby acknowledged, we, the undersigned inventor(s):

Kevin Ceurter; Russell Aoki; Anthony Valpiani; Eric W. Buddrius; Mustafa Haswarey; Rolf Laido; Thomas Boyd; Bijoyraj Sahu; Shelby A. Ferguson; Rachel Taylor; Daniel Neumann

hereby sell, assign, and transfer to:

Intel Corporation

a corporation of Delaware, having a principal place of business at 2200 Mission College Boulevard, Santa Clara, California, 95054 USA ("Assignee"), and its successors, assigns, and legal representatives, the entire right, title, and interest for the United States and all other countries, in and to any and all inventions and improvements that are disclosed in the application for the patent entitled:

SERVER MICROPROCESSOR CARRIER WITH GUIDING ALIGNMENT ANTI-TILT AND AUTOMATIC THERMAL INTERFACE MATERIAL SEPARATION FEATURES FOR USE IN LAND GRID ARRAY SOCKETS

(I hereby authorize and request any attorney having appropriate authority from the assignee to insert on the designated lines below, the filing date and application number of said application when known.)

which was filed on March 30, 2018 as

United States Application Number 15/942,263 and

which has been executed by the undersigned prior hereto or concurrently herewith on the date(s) indicated below,

and in and to said application and all Additional Applications, and all other patent applications that have been or shall be filed in the United States and all other countries and international filing offices on any of said inventions and improvements; and in and to all original and reissued patents that have been or shall be issued in the United States and all other countries and international filing offices on said inventions and improvements; and in and to all rights of priority resulting from the filing of said applications; as used herein "Additional Applications" includes but is not limited to design, utility, utility model, divisional, continuing, continuation-in-part, substitute, renewal, reissue, and national phase applications on said inventions and improvements;

and agree that said Assignee may apply for and receive a patent or patents for said inventions and improvements in its own name; and that, when requested, without charge to, but at the expense of, said Assignee, its successors, assigns, and legal representatives, to carry out in good faith the intent and purpose of this Assignment, the undersigned will execute

Corporate
NEO Document
EMPLOYEE AGREEMENT

In exchange for being employed by Intel Corporation, its subsidiaries, affiliates, or successors (hereinafter "INTEL"), I agree that:

1. While working for INTEL, I will perform my assigned duties and comply with all INTEL policies, procedures, guidelines, rules and instructions including Intel's Business Code of Conduct.
2. Without additional compensation, I will promptly disclose and, to the full extent allowed by law, assign to INTEL all rights to which I may be entitled with respect to designs, trademarks, copyrights, maskworks, discoveries, formulae, processes, manufacturing techniques, trade secrets, inventions, improvements, ideas or copyrightable works: (i) relating to INTEL's business, whether or not developed during normal working hours; or (ii) which were developed with the use or aid of any INTEL equipment, supplies, or facilities; or (iii) which used any proprietary or confidential information of INTEL or proprietary or confidential information of a third party, access to which I obtained through INTEL.
- 3.
4. At all times, both during and after my INTEL employment, I will do whatever is reasonably requested by INTEL, at INTEL's expense, to assist INTEL in obtaining and enforcing INTEL's rights throughout the world with respect to the assignments which I have made or am obligated to make to INTEL under this Agreement.
5. At all times, both during and after my employment by INTEL, I will hold in confidence and will not use (except for the benefit of INTEL) or disclose without INTEL's written authorization any information (technical or otherwise) I had access to or created during the period of my employment which pertains to any aspect of INTEL's business and is either unknown to actual or potential competitors of INTEL or is proprietary or confidential information of INTEL, its customers, or its suppliers, until such information either becomes generally known outside INTEL by legal means, or for the maximum period of time for maintaining trade secrets as permitted by law in the state in which I am employed, if such period is shorter, I agree not to make unauthorized copies of such confidential information and to return to INTEL upon my termination, or upon INTEL's request, all tangible forms of such confidential information including drawings, computerized data or programs, specifications, documents, devices, models, list of employees, or any other INTEL confidential material.
- 6.
- 7.
- 8.
- 9.
10. I certify and acknowledge that I have carefully read all of the provisions of this Agreement and that I understand and will fully and faithfully comply with such provisions.

INTEL

By:



F. THOMAS DUNLAP, JR.
Vice President,
General Counsel and Secretary

EMPLOYEE

Signature


Kevin J. Curter

Printed Name (please print clearly)

()

Social Security Number

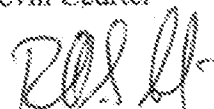
10/3/94

Date

all Additional Applications, and all other patent applications on any and all said inventions and improvements; execute all rightful oaths, assignments, powers of attorney, and other papers; communicate to said Assignee, its successors, assigns, and legal representatives all facts known to the undersigned relating to said inventions and improvements and the history thereof; and generally assist said Assignee, its successors, assigns, or legal representatives in securing and maintaining proper patent protection for said inventions and improvements and for vesting title to said inventions and improvements, and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns, and legal representatives; and

covenant with said Assignee, its successors, assigns, and legal representatives that no assignment, grant, mortgage, license, or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

Kevin Ceurter



Russell Aoki

Date signed

5-6-18

Date signed

Anthony Valpiani

Date signed

Eric W. Buddrus

Date signed

Mustafa Haswarey

Date signed

Rolf Laido

Date signed

Thomas Boyd

Date signed

Bijoyraj Sahu

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Shelby A. Ferguson

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Rachel Taylor

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Daniel Neumann

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Date signed

Anthony Valpiani

Date signed



Eric W. Buddrius

4/11/18

Date signed



Mustafa Haswarey

04/10/18

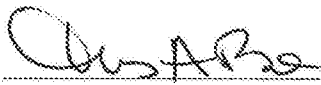
Date signed



Rolf Laido

4/10/18


Date signed



Thomas Boyd

4/10/18

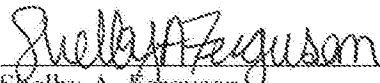
Date signed



Bijoyraj Sahu

04/11/18

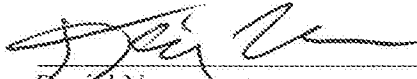
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Thomas Boyd

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Bijoyraj Sahu

Date signed

Shelby A. Ferguson

Date signed

Rachel M Taylor
Rachel Taylor

April 18, 2018
Date signed

Daniel Neumann

Date signed